

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent P48D1-US

In the application of: Pedersen et al.

Application No.: 09/539,287 Filing Date: March 30, 2000

For: Lithographically Defined Microelectronic

Contact Structures

Examiner: Q. Vu

Group Art Unit: 2841

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TECHNOLOGY CENTER 2800

INFORMATION DISCLOSURE STATEMENT (IDS)

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Listed on an attached Form PTO/SB/08A is information known to applicant(s). A copy of each listed publication, U.S. and foreign patent document, and pending U.S. application (including drawings and claims), is being submitted herewith, along with a concise explanation of information in a foreign language, if any, pursuant to 37 C.F.R. §1.97-1.98.

Applicants respectfully request that the listed information be considered by the Examiner and be made of record in the above-identified application. The Examiner is requested to initial and return the attached Form PTO/SB/08A in accordance with MPEP §609.

This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in §1.56.

Patent P48D1-US

	This appl	stateme y):	ent quali	fies under 37 C.F.R. §1.97, subsection (b) because (check all that	
			(1)	It is being filed within 3 months of the application filing date (other than the filing date of a continued prosecution application under §1.53(d))	
			(2)	 OR It is being filed within 3 months of entry of a national stage 	
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37 C.F.R. §1.97(c). If this statement is being filed after the latest of: (1) three beyond the filing date of a national application; (2) three months beyond the do of the national stage as set forth in §1.491 in an international application; (3) the date of a first Office action on the merits, or (4) the mailing date of a first Office action under §1.114, but I mailing date of the earlier of a final office action under §1.113, a notice of under §1.311, or an action that otherwise closes prosecution in the application.					
		a state	ement a	s specified in §1.97(e) is provided below; or	
		a fee include	of \$180 ed with	0.00 as set forth in §1.17(p) is authorized below, enclosed, or the payment of other papers filed together with this statement.	
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	A.	a state	ment as	s specified in §1.97(e) is provided below; and	
	B.	a fee d include	of \$180 d with t	.00 as set forth in §1.17(p) is authorized below, enclosed, or he payment of other papers filed together with this statement.	

Patent P48D1-US

Fee Authorization. Although Applicants believe that no fee is due in connection with the \boxtimes filing of this paper, the Commissioner is hereby authorized to charge any fee due, or credit any overpayment associated, with this communication to Deposit Account No. 50-0285 (Order No. P48D1-US).

Respectfully submitted,

Date: May 1, 2002

Reg. No. 39,923

FormFactor, Inc. Legal Department 2140 Research Dr. Livermore, CA 94550

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PATENT P48D1-US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE.

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NOTICE OF RELATED PATENTS AND APPLICATIONS

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Applicants wish to draw the Examiner's attention to the following commonly owned applications and patents (and the art cited therein), whose subject matter may be deemed related to the subject matter of the above-identified application.

US pat. appl. serial no.: 09/753,310 (P34D1-US) filed December 29, 2000 US pat. appl. serial no.: 09/752,853 (P34D2-US) filed December 29, 2000 US pat. appl. serial no.: 09/023,859 (P47-US) February 13, 1998 filed US pat. appl. serial no.: 09/795,024 (P73D1-US) filed February 26, 2001 US pat. appl. serial no.: 09/777,348 (P74D1-US) filed February 5, 2001 US pat. appl. serial no.: 09/364,788 (P84-US) filed July 30, 1999 US pat. appl. serial no.: 09/364,855 filed (P96-US) July 30, 1999 US pat. appl. serial no.: 09/752,640 (P96D1-US) filed December 29, 2000

US pat. no.: 6,184,053 (P35-US) issued February 6, 2001 US pat. no.: 6,268,015 (P73-US) issued July 31, 2001 US pat. no.: 6,255,126 (P74-US) issued July 3, 2001

Respectfully submitted,

Date: May 1, 2002

N. Kenneth Burraston

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Modified Form PTO/SB/08A

Complete If Known
er 09/539,287

March 30, 2000
tor Pedersen et al.

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Substitute for form 1449A/PTO

 (use as many sheets as necessary)
 Group Art Unit
 2841

 Examiner Name
 Q. Vu

 Sheet
 1
 of
 2
 Attorney Docket No.
 P48D1-US

Application Number

First Named Inventor

Filing Date

		1	U.S. PATE	NT DOCUMENTS		
Examiner	Cite	U.S. Patent D		Name of Patentee or	Publication	Relevant
Initials*	No.1	Number	Kind Code ²	Applicant	Date	Portions
	1	2002/19152	A1	Eldridge et al.	2/14/2002	
	2	5070297		Kwon et al.	12/3/1991	
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	6	5391521		Kim	2/21/1995	
	7	5455390		DiStefano et al.		
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-	21	6184053		Eldridge et al.	2/6/2001	

Examiner	Date	
Signature	Considered	

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication

¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.



Modified Form PTO/SB/08A

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Substitu	te for form 1449A/PTO	V	> ,	Complete If Known		
		~~~	PANEMAY	Application Number	09/539,287	
ì	ORMATION DI			Filing Date	March 30, 2000	
STA	TEMENT BY A	APPL	ICANT	First Named Inventor	Pedersen et al.	
	(use as many sheets as	necess	ary)	Group Art Unit	2841	
				Examiner Name	Q. Vu	
Sheet	2	of	2	Attorney Docket No.	P48D1-US	

FOREIGN PATENT DOCUMENTS									
Examiner Initials	Cite No. ¹	Forei Office ³	gn Patent Do Number ⁴ I	cument Kind Code ⁵	Name of Patentee or Applicant	Publication Date	Relevant Portions	T ⁶	
	22	CH	661129	A5		6/30/1987		<del>.</del>	
	23	JP	7-021968		w/ English abstract	1/24/1995			
	24	WO	96/02068		DiStefano et al.	1/25/1996			
	25	WO	97/43653		Khandros et al.	11/20/1997			

	OTE	IER PRIOR ART – NONPATENT LITERATURE DOCUMENTS			
Examiner   Cite   Include name of the author (in CAPITAL LETTERS), title of the article (when					
Initials*					
		date, page(s), volume-issue number(s), publisher, city and/or country where published	<u> </u>		
	26	ABOLAFIA, "Tapered Vias In A Photosensitive Dielectric Film," IBM			
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		Polyimide Packaging Structures," IBM Technical Disclosure Bulletin, vol.			
		34 no. 10A (March 1992), pp. 368-69			
	28	KONG et al., "Integrated Electrostically Resonant Scan Tip For An			
		Attomic Force Microscope," Journal of Vacuum Science & Technology,			
		Vol. 11 No. 3 (May/June 1993), pp. 634-641			
	29	"Thin Film Substrate For Wire Bonding," IBM Technical Disclosure			
		Bulletin, vol. 32 No. 10A (March 1990), pp. 80-81			

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Signature	Considered	

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